SCOPE :

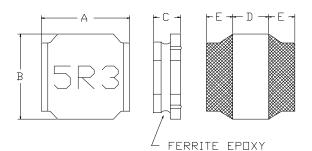
This specification applies to the Pb Free high current type SMD inductors for MNR-6012-SERIES

PRODUCT INDENTIFICATION

<u>MNR</u> - <u>6012</u> - <u>5R3</u> <u>M-RU</u> ① ② ③ ④

- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- Tolerance Code

(1) SHAPES AND DIMENSIONS



A :	6.0±0.2	mm
B:	6.0±0.2	mm
C:	1.20Max.	mm
D:	3.10Тур.	mm
E:	1.45Тур.	mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

SRF : HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60 $^\circ\!\! C$ Max.
- (3)-2 Operate temperature range $-40^\circ\!\!C\!\sim\!+125^\circ\!\!C$
 - (Including self temp. rise)
- (3)-3 Storage temperature range $-40^\circ C \sim +125^\circ C$



TABLE 1

MAGLAYERS	Inductance	Percent	L Test SRF(MHz) Resistance Rated DC Curre		C Current	Marking		
PT/NO.	L(µH)	Tolerance	Frequency	Min.	RDC(Ω)±20%	IDC1(A)	IDC2(A)	warking
MNR-6012-3R3□-RU	3.3	M,N	100KHz/0.25V	42	90m	1.80	1.50	3R3
MNR-6012-5R3RU	5.3	M,N	100KHz/0.25V	34	0.110	1.50	1.40	5R3
MNR-6012-6R8 -RU	6.8	M,N	100KHz/0.25V	30	0.165	1.30	1.18	6R8
MNR-6012-8R2 -RU	8.2	M,N	100KHz/0.25V	25	0.185	1.10	1.10	8R2
MNR-6012-100 -RU	10	M,N	100KHz/0.25V	22	0.235	1.00	1.00	100

※ □ specify the inductance tolerance,M(±20%),N(±30%)

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.)

Rated DC Current : The less value whith is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	л				
		R5 45±2 45±2 10 20 R340				
		PRESSURE ROD figure-1				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Saldarahiliju	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
Solderability	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		$130 \sim 150^{\circ}$ and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
	a temperature of 245±5℃.					
	More than 90% of the electrode sections shall be couered					
		with new solder smoothly when the sample is taken out of				
		the solder bath.				



MECHANICAL

TEST ITEM		SPECIFICATION			
Resistance to Soldering heat	There shall be no damage or problems.	SPECIFICATIONTemperature profile of reflow soldering $300 - 250$ $300 - (Peak temperature 20013°C 10 sec200 - 25030 sec Mn200 - 25030 sec Mn200 - 25030 sec Mn150 - 180°C30 sec Mn100 - 150°C30 sec Mn100 - 150°C30 sec Mn50 - 180°C30 sec Mn100 - 150°C30 sec Mn100 - 150°C30 sec Mn100 - 150°C30 sec Mn100 - 150°C2 mn2 mn10 sec2 mn10 sec10 sec2 mn10 sec2 mn10 sec10 sec$			
		condition shown in the above profile for 1 time.			

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS		
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top		
resistance	no other	surface and the terminal.		
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.		
	problems.			
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top		
withstand	no other	surface and the terminal of this sample		
voltage	damage or			
	problems.			
Temperature	∆L/L20° C≦±10%	The test shall be performed after the sample has stabilized in		
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$,and the value		
		calculated based on the value applicable in a normal		
		temperature and narmal humidity shall be $ riangle L/L20^{\circ}C \leq \pm 10\%$.		



ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION					
High temperature	∆L/Lo≦±5%	\triangle L/Lo \leq ±5% The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperature of 85±2 $^\circ\!\!\mathbb{C}$ and a normal humidity.					
	There shall be	Upon completion of the measurement shall be made after the					
	no mechanical	sample	sample has been left in a normal temperature and normal				
	damage.	humidit	y for 1	hour.			
Low temperature	∆L/Lo≦±5%	The san	nple sl	hall be left for 96±4 hou	rs in an atmosphere wi	th	
storage		a tempe	erature	e of -25±3℃.			
	There shall be	Upon co	omplet	tion of the test, the mea	surement shall be mad	е	
	no mechanical	after the	after the sample has been left in a normal temperature and				
	damage.	normal	humid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple sl	hall be subject to 5 cont	inuos cycles, such as s	shown	
temperature		in the ta	ble 2	below and then it shall b	be subjected to standar	ď	
	There shall be	atmosp	heric o	conditions for 1 hour, af	ter which measuremen	t	
	no other dama-	shall be	made	.			
	ge of problems						
			r	table 2			
				Temperature	Duration		
			1	− 25±3° C	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
		3	85±2℃	30 min.			
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in a temperature of					
-		$40\pm2^{\circ}$ and a humidity(RH) of 90 \sim 95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and normal humidity more than 1 hour.					
	damage.						
Test conditions :	1	U					
The s	sample shall be reflow	w soldered	d onto	the printed circuit boar	d in every test.		



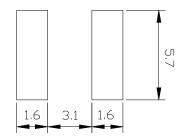
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

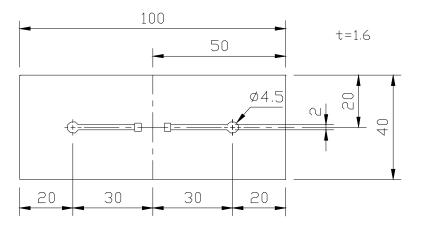
(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)



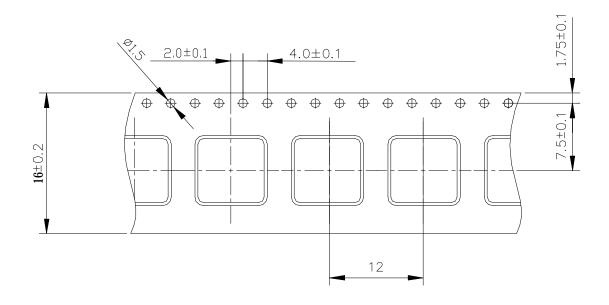


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

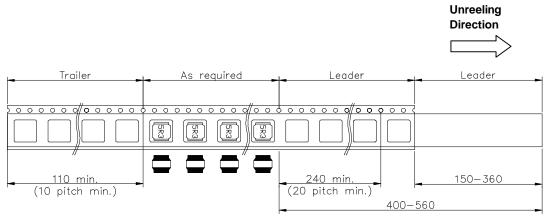




(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)

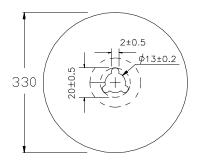


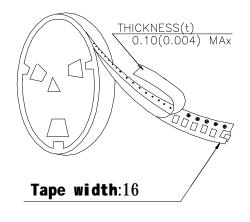
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

3500 pcs/Reel

The products are packaged so that no damage will be sustained.

